## feATURES

- Sample Rate: 100ksps
- Complete 16-Bit Solution on a Single 5V Supply
- Unipolar Input Range: OV to 4V (LTC1605-1)
- Bipolar Input Range: $\pm 4 \mathrm{~V}$ (LTC1605-2)
- Power Dissipation: 55mW Typ
- Signal-to-Noise Ratio: 86dB Typ
- Operates with Internal or External Reference
- Internal Synchronized Clock
- 28-Pin 0.3" PDIP and SSOP Packages


## APPLICATIONS

- Industrial Process Control
- Multiplexed Data Acquisition Systems
- High Speed Data Acquisition for PCs
- Digital Signal Processing


## DESCRIPTIOn

The LTC ${ }^{\circledR 1605-1 / L T C 1605-2 ~ a r e ~ 100 k s p s, ~ s a m p l i n g ~}$ 16-bit A/D converters that draw only 55 mW (typical) from a single 5V supply. These easy-to-use devices include a sample-and-hold, precision reference, switched capacitor successive approximation A/D and trimmed internal clock.

The LTC1605-1's input range is 0 V to 4 V while the LTC1605-2's input range is $\pm 4 \mathrm{~V}$. An external reference can be used if greater accuracy over temperature is needed.

The ADC has a microprocessor compatible, 16-bit or two byte parallel output port. A convert start input and a data ready signal (BUSY) ease connections to FIFOs, DSPs and microprocessors.
$\mathbf{\triangle}$, LTC and LT are registered trademarks of Linear Technology Corporation.

## TYPICAL APPLICATION

LTC1605-1 Low Power, 100kHz, 16-Bit Sampling ADC on 5V Supply


Typical INL Curve


1605-1/2 TA02/G04

ABSOLUTE MAXIMUM RATINGS
(Notes 1, 2)
VANA ........................................................................ 7 V
$V_{\text {DIG }}$ to $V_{\text {ANA }}$......................................................... 0.3 V
VDIG ........................................................................ 7 V
Ground Voltage Difference
DGND, AGND1 and AGND2 ............................. $\pm 0.3 \mathrm{~V}$
Analog Inputs (Note 3)
$V_{\text {IN }} . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . ~$
$\pm 25 \mathrm{~V}$
CAP ........................... $V_{\text {ANA }}+0.3 \mathrm{~V}$ to AGND2 - 0.3 V
REF ...................................Indefinite Short to AGND2 Momentary Short to $V_{\text {ANA }}$
Digital Input Voltage (Note 4) ........ VDGND -0.3 V to 10 V
Digital Output Voltage ........ $V_{\text {DGND }}-0.3 \mathrm{~V}$ to $\mathrm{V}_{\text {DIG }}+0.3 \mathrm{~V}$
Power Dissipation $\qquad$ 500 mW

## Operating Ambient Temperature Range

 LTC1605-1C/LTC1605-2C $\qquad$ $0^{\circ} \mathrm{C}$ to $70^{\circ} \mathrm{C}$LTC1605-1I/LTC1605-2I $\qquad$ $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$
Storage Temperature Range .................. $-65^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$ Lead Temperature (Soldering, 10 sec ) .................. $300^{\circ} \mathrm{C}$

## PACKAGE/ORDER INFORMATION



Consult factory for Military grade parts.

CONVERTER CHARACTERISTICS
The © denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$. With external reference (Notes 5, 6).

| PARAMETER | CONDITIONS |  | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Resolution |  | $\bullet$ | 16 |  |  | Bits |
| No Missing Codes |  | $\bullet$ | 15 |  |  | Bits |
| Transition Noise |  |  |  | 1 |  | $\mathrm{LSB}_{\text {RMS }}$ |
| Integral Linearity Error | (Note 7) | $\bullet$ |  |  | $\pm 3$ | LSB |
| Zero Error | Ext. Reference $=2.5 \mathrm{~V}$ (Note 8) | $\bullet$ |  |  | $\pm 10$ | mV |
| Zero Error Drift |  |  |  | $\pm 2$ |  | ppm $/{ }^{\circ} \mathrm{C}$ |
| Full-Scale Error Drift |  |  |  | $\pm 7$ |  | ppm/ ${ }^{\circ} \mathrm{C}$ |
| Full-Scale Error | Ext. Reference $=2.5 \mathrm{~V}$ (Notes 12, 13) | $\bullet$ |  |  | $\pm 0.50$ | \% |
| Full-Scale Error Drift | Ext. Reference $=2.5 \mathrm{~V}$ |  |  | $\pm 2$ |  | ppm/ ${ }^{\circ} \mathrm{C}$ |
| Power Supply Sensitivity $V_{\text {ANA }}=V_{D I G}=V_{D D}$ | $V_{D D}=5 \mathrm{~V} \pm 5 \%$ (Note 9) |  |  |  | $\pm 8$ | LSB |

AחALOG IMPUT
The $\bullet$ denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$. (Note 5)

| SYMBOL | PARAMETER | CONDITIONS | MIN | TYP | MAX |
| :--- | :--- | :--- | :---: | :---: | :---: |
| $V_{\text {IN }}$ | Analog Input Range (Note 9) | $4.75 \mathrm{~V} \leq V_{\text {ANA }} \leq 5.25 \mathrm{~V}, 4.75 \mathrm{~V} \leq \mathrm{V}_{\text {DIG }} \leq 5.25 \mathrm{~V}$ |  |  |  |
|  |  | LTC1605-1 <br> LTC1605-2 | $\bullet$ | 0 to 4 |  |
| $C_{\text {IN }}$ | Analog Input Capacitance |  | $\bullet$ | $\pm 4$ | V |
| $R_{\text {IN }}$ | Analog Input Impedance |  | 10 | V |  |

DYOAMIC ACCURACY
The o denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$. (Notes 5, 14)

| SYMBOL | PARAMETER | CONDITIONS | MIN | TYP | MAX |
| :--- | :--- | :--- | :---: | :---: | :---: |
| UNITS |  |  |  |  |  |
| S/(N + D) | Signal-to-(Noise + Distortion) Ratio | 1 kHz Input Signal (Note 14) | 87 | dB |  |
|  |  | 10 kHz Input Signal | 85 | dB |  |
|  |  | $20 \mathrm{kHz},-60 \mathrm{~dB}$ Input Signal | 30 | dB |  |
| THD | Total Harmonic Distortion | 1 kHz Input Signal, First 5 Harmonics | -101 | dB |  |
|  |  | 10 kHz Input Signal, First 5 Harmonics | -92 | dB |  |
|  | Peak Harmonic or Spurious Noise | 1 kHz Input Signal | -101 | dB |  |
|  |  | 10 kHz Input Signal | -92 | dB |  |
|  | Full-Power Bandwidth | (Note 15) | 275 | kHz |  |
|  | Aperture Delay |  | 40 | ns |  |
|  | Aperture Jitter |  | Sufficient to Meet AC Specs |  |  |
|  | Transient Response | Full-Scale Step (Note 9) |  | $\mu$ |  |
|  | Overvoltage Recovery | (Note 16) |  | ns |  |

## internal reference characteristics <br> The o denotes the specifications which apply over the

full operating temperature range, otherwise specifications are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$. (Note 5)

| PARAMETER | CONDITIONS |  | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $V_{\text {REF }}$ Output Voltage | $\mathrm{I}_{\text {OUT }}=0$ | $\bullet$ | 2.470 | 2.500 | 2.520 | V |
| $V_{\text {REF }}$ Output Tempco | $\mathrm{I}_{\text {OUT }}=0$ |  |  | $\pm 5$ |  | ppm/ ${ }^{\circ} \mathrm{C}$ |
| Internal Reference Source Current |  |  |  | 1 |  | $\mu \mathrm{A}$ |
| External Reference Voltage for Specified Linearity | (Notes 9, 10) |  | 2.30 | 2.50 | 2.70 |  |
| External Reference Current Drain | Ext. Reference = 2.5V (Note 9) | - |  |  | 100 | $\mu \mathrm{A}$ |
| CAP Output Voltage | IOUT $=0$ |  |  | 2.50 |  | V |

## DIGITAL InPUTS AnD DIGITAL OUTPUTS <br> The © denotes the specifications which apply over the

 full operating temperature range, otherwise specifications are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$. (Note 5)| SYMBOL | PARAMETER | CONDITIONS |  |  | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {IH }}$ | High Level Input Voltage | $V_{D D}=5.25 \mathrm{~V}$ |  | $\bullet$ | 2.4 |  |  | V |
| VIL | Low Level Input Voltage | $V_{D D}=4.75 \mathrm{~V}$ |  | $\bullet$ |  |  | 0.8 | V |
| $\underline{\text { IN }}$ | Digital Input Current | $\mathrm{V}_{\text {IN }}=0 \mathrm{~V}$ to $\mathrm{V}_{\mathrm{DD}}$ |  | $\bullet$ |  |  | $\pm 10$ | $\mu \mathrm{A}$ |
| $\mathrm{C}_{\text {IN }}$ | Digital Input Capacitance |  |  |  |  | 5 |  | pF |
| $\mathrm{V}_{\mathrm{OH}}$ | High Level Output Voltage | $V_{D D}=4.75 \mathrm{~V}$ | $\mathrm{I}_{0}=-10 \mu \mathrm{~A}$ |  |  | 4.5 |  | V |
|  |  |  | $\mathrm{I}_{0}=-200 \mu \mathrm{~A}$ | $\bullet$ | 4.0 |  |  | V |
| $\mathrm{V}_{0 \mathrm{~L}}$ | Low Level Output Voltage | $V_{D D}=4.75 \mathrm{~V}$ | $\mathrm{I}_{0}=160 \mu \mathrm{~A}$ |  |  | 0.05 |  | V |
|  |  |  | $\mathrm{I}_{0}=1.6 \mathrm{~mA}$ | $\bullet$ |  | 0.10 | 0.4 | V |
| $\mathrm{I}_{02}$ | Hi-Z Output Leakage D15 to D0 | $V_{\text {OUT }}=0 \mathrm{~V}$ to $\mathrm{V}_{\text {DD }}, \overline{\mathrm{CS}}$ High |  | $\bullet$ |  |  | $\pm 10$ | $\mu \mathrm{A}$ |
| $\mathrm{C}_{02}$ | Hi-Z Output Capacitance D15 to D0 | $\overline{\mathrm{CS}}$ High (Note 9) |  | $\bullet$ |  |  | 15 | pF |
| ISOURCE | Output Source Current | $\mathrm{V}_{\text {OUT }}=0 \mathrm{~V}$ |  |  |  | -10 |  | mA |
| ISINK | Output Sink Current | $V_{\text {OUT }}=V_{\text {DD }}$ |  |  |  | 10 |  | mA |

TIMING CHARACTERISTICS The odennes ste senefiriations wicich paply ver the full operating temereature range, otherwise specifications are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$. (Note 5)

| SYMBOL | PARAMETER | CONDITIONS |  | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{f}_{\text {SAMPLE(MAX) }}$ | Maximum Sampling Frequency |  | $\bullet$ | 100 |  |  | kHz |
| toonv | Conversion Time |  | $\bullet$ |  |  | 8 | $\mu \mathrm{S}$ |
| $\mathrm{t}_{\mathrm{ACQ}}$ | Acquisition Time |  | $\bullet$ |  |  | 2 | $\mu \mathrm{s}$ |
| $\mathrm{t}_{1}$ | Convert Pulse Width | (Note 11) | $\bullet$ | 40 |  |  | ns |
| $\mathrm{t}_{2}$ | Data Valid Delay After R/C̄ $\downarrow$ | (Note 9) | $\bullet$ |  |  | 8 | $\mu \mathrm{S}$ |
| $\mathrm{t}_{3}$ | $\overline{\text { BUSY }}$ Delay from R/C$\downarrow$ | $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ | $\bullet$ |  |  | 65 | ns |
| $\mathrm{t}_{4}$ | $\overline{\text { BUSY }}$ Low |  |  |  |  | 8 | $\mu \mathrm{S}$ |
| $\mathrm{t}_{5}$ | $\overline{\text { BUSY }}$ Delay After End of Conversion |  |  |  | 220 |  | ns |
| $\mathrm{t}_{6}$ | Aperture Delay |  |  |  | 40 |  | ns |
| $\mathrm{t}_{7}$ | Bus Relinquish Time |  | $\bullet$ | 10 | 35 | 83 | ns |
| $\mathrm{t}_{8}$ | $\overline{\text { BUSY }}$ Delay After Data Valid |  | $\bullet$ | 50 | 200 |  | ns |
| $\mathrm{tg}_{9}$ | Previous Data Valid After R// $\downarrow$ |  |  |  | 7.4 |  | $\mu \mathrm{S}$ |
| $\mathrm{t}_{10}$ | R/C̄ to $\overline{C S}$ Setup Time | (Notes 9, 10) |  | 10 |  |  | ns |
| $\mathrm{t}_{11}$ | Time Between Conversions |  |  | 10 |  |  | $\mu \mathrm{S}$ |
| $\mathrm{t}_{12}$ | Bus Access and Byte Delay | (Notes 9, 10) |  | 10 |  | 83 | ns |

## POWER REQUIREMERTS <br> The denotes the specifications which apply over the full operating temperature

range, otherwise specifications are at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$. (Note 5)

| SYMBOL | PARAMETER | CONDITIONS | MIN | TYP | MAX | UNITS |
| :--- | :--- | :--- | :--- | :--- | :---: | :---: |
| $V_{D D}$ | Positive Supply Voltage | (Notes 9, 10) | 4.75 | 5.25 | V |  |
| $I_{D D}$ | Positive Supply Current |  | $\bullet$ | 11 | 16 | mA |
| $P_{\text {DIS }}$ | Power Dissipation |  |  | 55 | 80 | mW |

Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.
Note 2: All voltage values are with respect to ground with DGND, AGND1 and AGND2 wired together (unless otherwise noted).
Note 3: When these pin voltages are taken below ground or above $\mathrm{V}_{\text {ANA }}=$ $V_{D I G}=V_{D D}$, they will be clamped by internal diodes. This product can handle input currents of greater than 100 mA below ground or above $V_{D D}$ without latch-up.
Note 4: When these pin voltages are taken below ground, they will be clamped by internal diodes. This product can handle input currents of 90 mA below ground without latchup. These pins are not clamped to $\mathrm{V}_{\mathrm{DD}}$.
Note 5: $V_{D D}=5 \mathrm{~V}, f_{\text {SAMPLE }}=100 \mathrm{kHz}, \mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=5 \mathrm{~ns}$ unless otherwise specified.
Note 6: Linearity, offset and full-scale specifications apply for a $\mathrm{V}_{\text {IN }}$ input with respect to ground.
Note 7: Integral nonlinearity is defined as the deviation of a code from a straight line passing through the actual end points of the transfer curve. The deviation is measured from the center of the quantization band.
Note 8: Zero error for the LTC1605-1 is the voltage measured from 0.5 LSB when the output code flickers between 0000000000000000 and 0000000000000001 . Zero error for the LTC1605-2 is the voltage measured from -0.5 LSB when the output code flickers between 0000 000000000000 and 1111111111111111.

Note 9: Guaranteed by design, not subject to test.
Note 10: Recommended operating conditions.
Note 11: With $\overline{C S}$ low the falling $R / \bar{C}$ edge starts a conversion. If $R / \bar{C}$ returns high at a critical point during the conversion it can create small errors. For best results ensure that $R / \bar{C}$ returns high within $3 \mu s$ after the start of the conversion.
Note 12: As measured with fixed resistors shown in Figure 4. Adjustable to zero with external potentiometer.
Note 13: Full-scale error is the untrimmed deviation from ideal last code transition, divided by the full-scale range and includes the effect of offset error.
Note 14: All specifications in dB are referred to a full-scale 4 V input for the LTC1605-1 and to $\pm 4 \mathrm{~V}$ input for the LTC1605-2.
Note 15: Full-power bandwidth is defined as full-scale input frequency at which a signal-to-(noise + distortion) degrades to 60 dB or 10 bits of accuracy.
Note 16: Recovers to specified performance after ( $\pm 20 \mathrm{~V}$ ) input overvoltage for the LTC1605-1 and $\pm 15 \mathrm{~V}$ for the LTC1605-2.

## TYPICAL PERFORMANCE CHARACTERISTICS



## LTC 1605-1/LTC 1605-2

## PIn functions

$V_{\text {IN }}$ (Pin 1): Analog Input. Connect through a $200 \Omega$ resistor to the analog input. Full-scale input range is 0 V to 4 V for the LTC1605-1 and $\pm 4 \mathrm{~V}$ for the LTC1605-2.

AGND1 (Pin 2): Analog Ground. Tie to analog ground plane.
REF (Pin 3): 2.5V Reference Output. Bypass with $2.2 \mu \mathrm{~F}$ tantalum capacitor. Can be driven with an external reference.

CAP (Pin 4): Reference Buffer Output. Bypass with $2.2 \mu \mathrm{~F}$ tantalum capacitor.
AGND2 (Pin 5): Analog Ground. Tie to analog ground plane.

D15 to D8 (Pins 6 to 13): Three-State Data Outputs. $\mathrm{Hi}-\mathrm{Z}$ state when $\overline{\mathrm{CS}}$ is high or when $\mathrm{R} / \overline{\mathrm{C}}$ is low.
DGND (Pin 14): Digital Ground.
D7 to D0 (Pins 15 to 22): Three-State Data Outputs. $\mathrm{Hi}-\mathrm{Z}$ state when $\overline{\mathrm{CS}}$ is high or when $\mathrm{R} / \overline{\mathrm{C}}$ is low.

BYTE (Pin 23): Byte Select. With BYTE Iow, data will be output with Pin 6 (D15) being the MSB and Pin 22 (D0)
being the LSB. With BYTE high the upper eight bits and the lower eight bits will be switched. The MSB is output on Pin 15 and bit 8 is output on Pin 22. Bit 7 is output on Pin 6 and the LSB is output on Pin 13.
R/C्C (Pin 24): Read/Convert Input. With $\overline{\mathrm{CS}}$ low, a falling edge on $R / \bar{C}$ puts the internal sample-and-hold into the hold state and starts a conversion. With $\overline{\mathrm{CS}}$ low, a rising edge on $R / \bar{C}$ enables the output data bits.
$\overline{\mathrm{CS}}$ (Pin 25): $\overline{\text { Chip Select. Internally OR'd with R/ } \overline{\mathrm{C}} \text {. With }}$ R/C low, a falling edge on $\overline{C S}$ will initiate a conversion. With $\mathrm{R} / \overline{\mathrm{C}}$ high, a falling edge on $\overline{\mathrm{CS}}$ will enable the output data.
BUSY (Pin 26): Output Shows Converter Status. It is low when a conversion is in progress. Data valid on the rising edge of BUSY. $\overline{\mathrm{CS}}$ or R/C must be high when BUSY rises or another conversion will start without time for signal acquisition.
$\mathbf{V}_{\text {ANA }}$ (Pin 27): 5V Analog Supply. Bypass to ground with a $0.1 \mu \mathrm{~F}$ ceramic and a $10 \mu \mathrm{~F}$ tantalum capacitor.
V $_{\text {DIG }}$ (Pin 28): 5V Digital Supply. Connect directly to Pin 27.

## fUnCTIONAL BLOCK DIAGRAM



## TEST CIRCUITS



## APPLICATIONS INFORMATION

## Conversion Details

The LTC1605-1/LTC1605-2 use a successive approximation algorithm and an internal sample-and-hold circuit to convert an analog signal to a 16 -bit or two byte parallel output. The ADC is complete with a precision reference and an internal clock. The control logic provides easy interface to microprocessors and DSPs. (Please refer to the Digital Interface section for the data format.)
Conversion start is controlled by the $\overline{C S}$ and $\mathrm{R} / \overline{\mathrm{C}}$ inputs. At the start of conversion, the successive approximation register (SAR) is reset. Once a conversion cycle has begun, it cannot be restarted.
During the conversion, the internal 16-bit capacitive DAC outputis sequenced by the SAR from the most significant bit (MSB) to the least significant bit (LSB). Referring to Figure $1, \mathrm{~V}_{\mathrm{IN}}$ is connected through the resistor divider and S1 to the sample-and-hold capacitor during the acquire phase and the comparator offset is nulled by the


Figure 1. LTC1605-1/LTC1605-2 Simplified Equivalent Circuit
autozero switch, S3. In this acquire phase, a minimum delay of $2 \mu \mathrm{~s}$ will provide enough time for the sample-andhold capacitor to acquire the analog signal. During the convert phase, S3 opens, putting the comparator into the compare mode. The input switch S 2 switches CsAMPLE to ground, injecting the analog input charge onto the summing junction. This input charge is successively compared with the binary-weighted charges supplied by the capacitive DAC. Bit decisions are made by the high speed comparator. At the end of a conversion, the DAC output balances the $\mathrm{V}_{\text {IN }}$ input charge. The SAR contents (a 16 bit data word) that represents the $\mathrm{V}_{\text {IN }}$ are loaded into the 16-bit output latches.

## Driving the Analog Inputs

The nominal input range for the LTC1605-1 is 0 V to 4 V or ( $1.6 \mathrm{~V}_{\text {REF }}$ ) and for the LTC1605-2 the input range is $\pm 4 \mathrm{~V}$ or ( $\left.\pm 1.6 \mathrm{~V}_{\text {REF }}\right)$. The inputs are overvoltage protected to $\pm 25 \mathrm{~V}$. The input impedance is typically $10 \mathrm{k} \Omega$; therefore, it should be driven by a low impedance source. Wideband noise coupling into the input can be minimized by placing a 1000pF capacitor at the input as shown in Figure 2. An NPO-type capacitor gives the lowest distortion. Place the capacitor as close to the device input pin as possible. If an amplifier is to be used to drive the input, care should be taken to select an amplifier with adequate accuracy, linearity and noise for the application. The following list is a summary of the op amps that are suitable for driving the LTC1605-1/LTC1605-2. More detailed information is available in the Linear Technology data books and LinearView ${ }^{\text {TM }}$ CD-ROM.

## APPLICATIONS INFORMATION

LT ${ }^{\circledR} 1007$ - Low noise precision amplifier. 2.7mA supply current $\pm 5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$ supplies. Gain bandwidth product 8MHz. DC applications.

LT1097 - Low cost, low power precision amplifier. $300 \mu \mathrm{~A}$ supply current. $\pm 5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$ supplies. Gain bandwidth product 0.7 MHz . DC applications.
LT1227-140MHz video current feedback amplifier. 10 mA supply current. $\pm 5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$ supplies. Low noise and low distortion.

LT1360-37MHz voltage feedback amplifier. 3.8 mA supply current. $\pm 5 \mathrm{~V}$ to $\pm 15 \mathrm{~V}$ supplies. Good AC/DC specs.

LT1363-50MHz voltage feedback amplifier. 6.3 mA supply current. Good AC/DC specs.
LT1364/LT1365 - Dual and quad 50MHz voltage feedback amplifiers. 6.3mA supply current per amplifier. Good AC/DC specs.

LT1468-90MHz, 22V/us 16-Bit Accurate Amplifier


Figure 2. Analog Input Filtering

## Internal Voltage Reference

The LTC1605-1/LTC1605-2 has an on-chip, temperature compensated, curvature corrected, bandgap reference, which is factory trimmed to 2.50 V . The full-scale range of the ADC is equal to ( $1.6 \mathrm{~V}_{\text {REF }}$ ) or nominally 0 V to 4 V for the LTC1605-1 and ( $\pm 1.6 \mathrm{~V}_{\text {REF }}$ ) or nominally $\pm 4 \mathrm{~V}$ for the LTC1605-2. The output of the reference is connected to the input of a unity-gain buffer through a 4 k resistor (see Figure 3). The input to the buffer or the output of the reference is available at REF (Pin 3). The internal reference can be overdriven with an external reference if more accuracy is needed. The buffer output drives the internal DAC and is available at CAP (Pin 4). The CAP pin can be used to drive a steady DC load of less than 2mA. Driving an AC load is not recommended because it can cause the performance of the converter to degrade.

For minimum code transition noise the REF pin and the CAP pin should each be decoupled with a capacitor to filter wideband noise from the reference and the buffer ( $2.2 \mu \mathrm{~F}$ tantalum ).

## Offset and Gain Adjustments

The LTC1605-1/LTC1605-2 offset and full-scale errors have been trimmed at the factory with the external resistors shown in Figure 4. This allows for external adjustment of offset and full scale in applications where absolute accuracy is important. See Figure 5 for the offset and gain trim circuit for the LTC1605-1/LTC1605-2. First adjust the offset to zero by adjusting resistor R3. Apply an input voltage of $30.5 \mu \mathrm{~V}$ ( 0.5 LSB ) and adjust R3 so the code is changing between 0000000000000001 and 0000000000000000 . The gain error is trimmed by adjusting resistor R4. An input voltage of 3.999908 V (FS -1.5 LSB ) is applied to $\mathrm{V}_{\text {IN }}$ and $\mathrm{R4}$ is adjusted until the output code is changing between 1111111111111110 and 1111111111111111 . Figure 6a shows the unipolar transfer characteristic of the LTC1605-1.

For the LTC1605-2, first adjust the offset to zero by adjusting resistor R3. Apply an input voltage of $-61 \mu \mathrm{~V}$ ( -0.5 LSB ) and adjust R3 so the code is changing between 1111111111111111 and 0000000000000000. The gain error is trimmed by adjusting resistor R4. An input voltage of $3.999817 \mathrm{~V}(+\mathrm{FS}-1.5 \mathrm{LSB})$ is applied to $\mathrm{V}_{\text {IN }}$ and $\mathrm{R4}$ is adjusted until the outut code is changing between 0111111111111110 and 011111111111 1111. Figure 6b shows the bipolar transfer characteristics of the LTC1605-2.

## DC Performance

One way of measuring the transition noise associated with a high resolution ADC is to use a technique where a DC signal is applied to the input of the ADC and the resulting output codes are collected over a large number of conversions. For example, in Figure 7 the distribution of output code is shown for a DC input that has been digitized 10000 times. The distribution is Gaussian and the RMS code transition is about 1LSB.

## APPLLCATIONS InFORMATION



Figure 3. Internal or External Reference Source


Figure 4. OV to 4V Input for the LTC1605-1 and $\pm 4 \mathrm{~V}$ for the LTC1605-2 Without Trim


Figure 5. OV to 4V Input for the LTC1605-1 and $\pm 4 \mathrm{~V}$ for the LTC1605-2 with Offset and Gain Trim


Figure 6a. LTC1605-1 Unipolar Transfer Characteristics


Figure 6B. LTC1605-2 Bipolar Transfer Characteristics


1605-1/2 F07
Figure 7. Histogram for 10000 Conversions

## APPLICATIONS Information

## DIGITAL INTERFACE

## Internal Clock

The ADC has an internal clock that is trimmed to achieve a typical conversion time of $7 \mu \mathrm{~s}$. No external adjustments are required and, with the typical acquisition time of $1 \mu \mathrm{~s}$, throughput performance of 100 ksps is assured.

## Timing and Control

Conversion start and data read are controlled by two digital inputs: CS and R/C. To start a conversion and put the sample-and-hold into the hold mode, bring $\overline{\mathrm{CS}}$ and $R / \bar{C}$ low for no less than 40ns. Once initiated, it cannot be restarted until the conversion is complete. Converter status is indicated by the BUSY output and this is low while the conversion is in progress.
There are two modes of operation. The first mode is shown in Figure 8. The digital input $\mathrm{R} / \overline{\mathrm{C}}$ is used to control the start of conversion. $\overline{C S}$ is tied low. When R/ $\bar{C}$ goes low, the sample-and-hold goes into the hold mode and a conversion is started. BUSY goes low and stays low during the conversion and will go back high after the conversion has been completed and the internal output shift registers have been updated. R/C should remain low for no less than 40 ns. During the time R/ $\overline{\mathrm{C}}$ is low, the
digital outputs are in a $\mathrm{Hi}-\mathrm{Z}$ state. $\mathrm{R} / \overline{\mathrm{C}}$ should be brought back high within $3 \mu \mathrm{~s}$ after the start of the conversion to ensure that no errors occur in the digitized result. The second mode, shown in Figure 9, uses the CS signal to control the start of a conversion and the reading of the digital output. In this mode, the R/C input signal should be brought low no less than 10ns before the falling edge of $\overline{\mathrm{CS}}$. The minimum pulse width for $\overline{\mathrm{CS}}$ is 40 ns . When $\overline{\mathrm{CS}}$ falls, $\overline{B U S Y}$ goes low and will stay low until the end of the conversion. BUSY will go high after the conversion has been completed. The new data is valid when $\overline{\mathrm{CS}}$ is brought back low again to initiate a read. Again, it is recommended that both $\mathrm{R} / \overline{\mathrm{C}}$ and $\overline{\mathrm{CS}}$ return high within $3 \mu \mathrm{~s}$ after the start of the conversion.

## Output Data

The output data can be read as a 16-bit word or it can be read as two 8-bit bytes. The format of the output data is straight binary for the LTC1605-1 and two's complement for the LTC1605-2. The digital input pin BYTE is used to control the two byte read. With the BYTE pin low, the first eight MSBs are output on the D15 to D8 pins and the eight LSBs are output on the D7 to DO pins. When the BYTE pin is taken high, the eight LSBs replace the eight MSBs (Figure 10).


Figure 8. Conversion Timing with Outputs Enabled After Conversion ( $\overline{C S}$ Tied Low)

## APPLICATIONS INFORMATION



Figure 9. Using $\overline{\mathrm{CS}}$ to Control Conversion and Read Timing


Figure 10. Using $\overline{C S}$ and BYTE to Control Data Bus Read Timing

## APPLLCATIONS InFORMATION

Dynamic Performance

FFT (Fast Fourier Transform) test techniques are used to test the ADC's frequency response, distortion and noise at the rated throughput. By applying a low distortion sine wave and analyzing the digital output using an FFT algorithm, the ADC's spectral content can be examined forfrequencies outside the fundamental. Figure 11 shows a typical LTC1605-2 FFT plot which yields a SINAD of 87 dB and THD of -101.1 dB .

## Signal-to-Noise Ratio

The Signal-to-Noise and Distortion Ratio (SINAD) is the ratio between the RMS amplitude of the fundamental input frequency to the RMS amplitude of all other frequency components at the A/D output. The output is band limited to frequencies from above DC and below half the sampling frequency. Figure 11 shows a typical SINAD of 87 dB with a 100 kHz sampling rate and a 1 kHz input.


1605-1/2 G07/F11
Figure 11. LTC1605-2 Nonaveraged 4096-Point FFT Plot

## Total Harmonic Distortion

Total Harmonic Distortion (THD) is the ratio of the RMS sum of all harmonics of the input signal to the fundamental itself. The out-of-band harmonics alias into the frequency band between DC and half the sampling frequency. THD is expressed as:
where $\mathrm{V}_{1}$ is the RMS amplitude of the fundamental frequency and $V_{2}$ through $V_{N}$ are the amplitudes of the second through Nth harmonics.

## Board Layout, Power Supplies and Decoupling

Wire wrap boards are not recommended for high resolution or high speed $A / D$ converters. To obtain the best performance from the LTC1605-1/LTC1605-2, a printed circuit board is required. Layout for the printed circuit board should ensure the digital and analog signal lines are separated as much as possible. In particular, care should be taken not to run any digital track alongside an analog signal track or underneath the ADC. The analog input should be screened by AGND.

Figures 12 through 15 show a layout for a suggested evaluation circuit which will help obtain the best performance from the 16-bit ADC. Additional information regarding the evaluation circuit and Gerber files for the PC board layout are available from Linear Technology or your local sales office. Pay particular attention to the design of the analog and digital ground planes. The DGND pin of the LTC1605-1/LTC1605-2 can be tied to the analog ground plane. Placing the bypass capacitor as close as possible to the power supply, the reference and reference buffer output is very important. Low impedance common returns for these bypass capacitors are essential to low noise operation of the ADC, and the PC track width for these lines should be as wide as possible. Also, since any potential difference in grounds between the signal source and ADC appears as an error voltage in series with the input signal, attention should be paid to reducing the ground circuit impedance as much as possible. The digital output latches and the onboard sampling clock have been placed on the digital ground plane. The two ground planes are tied together at the power supply ground connection.

$$
T H D=20 \log \frac{\sqrt{V_{2}^{2}+V_{3}^{2}+V_{4}^{2} \ldots+V_{N}^{2}}}{V_{1}}
$$

## APPLICATIONS INFORMATION



Figure 12. Component Side Silkscreen for the Suggested LTC1605-1/LTC1605-2 Evaluation Circuit


Figure 13. Bottom Side Showing Analog Ground Plane

ANALOG
GROUND PLANE


Figure 14. Component Side Showing Separate Analog and Digital Ground Plane

## LTC 1605-1/LTC 1605-2

APPLICATIONS Information


## TYPICAL APPLICATIONS

The circuit in Figure 16 is an example showing the LTC1605 16-bit A/D converter and LTC1391 8-channel MUX connected to a 68HC11 controller. The LTC1605's 16-bit data output is read in two 8-bit bytes using Pins 6 (MSB, Bit7) through 13 (Bit8, Bit0), connected to the HC11's PORTC. The MUX's 4-bit serial address data is sent using the controller's SPI.

The process to convert a channel's input signal is shown in sample listing A. It begins with shifting in the MUX's channel data while the $\overline{\text { SS }}$ signal is a logic high. The MUX channel address is latched on the falling edge of $\overline{S S}$ and the
chosen channel's input is applied at the LTC1605's input, Pin 1. Through the processor's PORTA, a low-going pulse is applied to the LTC1605's R/ $\bar{C}$ pin, initiating a conversion. The processor then monitors the BUSY output. When this signal becomes a logic high, signaling the end of conversion, the processor reads the high byte of the conversion through PORTC. The low byte is read through PORTC when the processor changes the BYTE signal to a logic high. The timing relationship of the control signals and data are shown in Figure 17.

## Sample Listing A

```
* *
* This example program selects the an LTC1391 MUX channel, initiates a*
* conversion, and retrieves conversion data. It stores the 16-bit data*
* in two consecutive memory locations. The program is designed for use*
* with the LTC1605's /CS tied to ground (see timing diagram in
* Figure 17).
*
****************************************************************************
*
* 68HC
***********************************************
*
PORTA EQU $1000 Parallel port A
* Use Bit0 as an input for the LTC1605's /BUSY signal
* Use Bit3 as an output driving the LTC1605's BYTE
* input
PIOC EQU $1002 Parallel I/O control register
*
PORTC EQU $1003 Port C data register
* "Bit7,Bit6,Bit5,Bit4,Bit3,Bit2,Bit1,Bit0"
DDRC EQU $1007 Port D data direction register
* "Bit7,Bit6,Bit5,Bit4,Bit3,Bit2,Bit1,Bit0"
* 1 = output, 0 = input
PORTD EQU $1008 Port D data register
* NOL "- , - , SS* ,CSK ;MOSI,MISO,
SPCR EQU $1028 SPI control register
* "SPIE,SPE ,DWOM,MSTR;SPOL,CPHA,SPR1,SPR0"
SPSR EQU $1029 SPI status register
* "SPIF,WCOL, - ,MODF;
SPDR EQU $102A SPI data register; Read-Buffer; Write-Shifter
* RAM variables to hold the LTC1605's 14 conversion result
*
DIN1 EQU $00 This memory location holds the LTC1605's bits 15 - 08
DIN2 EQU $01 This memory location holds the LTC1605's bits 07 - 00
MUX EQU $02 This memory location holds the MUX address data
```


## LTC 1605-1/LTC 1605-2

## TYPICAL APPLICATIONS


$\qquad$

## TYPICAL APPLICATIONS

```
* Retrieve the MUX address from memory *
* and send it to the LTC1391
******************************************
*
\begin{tabular}{|c|c|c|c|}
\hline & LDAA & MUX & Retrieve the MUX address from memory \\
\hline & ORAA & \#\$08 & Enable the selected MUX address \\
\hline & STAA & SPDR & Select the MUX channel \\
\hline WAIT1 & LDAA & SPSR & This loop waits for the SPI to complete a serial transfer/exchange by reading the SPI Status Register \\
\hline * & BPL & WAIT1 & The SPIF (SPI transfer complete flag) bit is the SPSR's MSB and is set to one at the end of an SPI transfer. The branch will occur while SPIF is a zero. \\
\hline * & BCLR & PORTD, & \(\% 00100000\) This forces a logic low on PORTD's SS*, latching the MUXes data \\
\hline
\end{tabular}
*
*****************************************
* Initiate a LTC1605 conversion *
********************************************
*
    BCLR PORTA,Y %00010000 Initiate a conversion
    BSET PORTA,Y %00010000 This sets the LTC1605's R/C* to a logic
                                high
*
*****************************************
* Set the LTC1605's BYTE input low to *
* ensure that the high byte is present *
* during the first read *
*****************************************
*
\begin{tabular}{lll} 
LDAA & PORTA & Get the contents of Port A \\
ANDA & \#\%11110111 & Set Bit3 low \\
STAA & PORTA & Set the LTC1605's BYTE input low
\end{tabular}
*
******************************************
* The next short loop ensures that the *
* LTC1605's conversion is finished *
* before starting the data transfer*
*******************************************
*
CONVENDLDAA PORTA Retrieve the contents of port A
    ANDA #%00000001 Look at Bit0
    Bit0 = Lo; the LTC1605's conversion is not
    complete
    Bit0 = Hi; the LTC1605's conversion is complete
    BEQ CONVEND Branch to the loop's beginning while Bit7
    remains low
```


## LTC1605-1/LTC 1605-2

## TYPICAL APPLICATIONS

```
* reads. The BYTE input is manipulated through Port A's Bit3. During *
* the first read when BYTE is low, the upper byte is read and stored in
* DIN1.During the second read when BYTE is high, the lower byte is *
* read and stored in DIN2.
****************************************************************************
LDAA PORTC Retrieve the LTC1605's high byte
STAA DIN1 Store the high byte
LDAA PORTA Get the contents of Port A
ORAA #%00001000 Set Bit3 high
STAA PORTA Set the LTC1605's BYTE input high
LDAA PORTC Retrieve the LTC1605's low byte
STAA DIN2 Store the high byte
PULA Restore the A register
PULY Restore the Y register
PULX Restore the X register
RTS
```



Figure 16. 8-Channel, 16-Bit Data Acquisition System with Interface to the 68HC11

PACKAGE DESCRIPTIOी Dimensions in inches (millimeters) unless otherwise noted.

## G Package

28-Lead Plastic SSOP (0.209)
(LTC DWG \# 05-08-1640)



NOTE: DIMENSIONS ARE IN MILLIMETERS
*DIMENSIONS DO NOT INCLUDE MOLD FLASH. MOLD FLASH
SHALL NOT EXCEED 0.152 mm ( $0.006^{\prime \prime}$ ) PER SIDE
**DIMENSIONS DO NOT INCLUDE INTERLEAD FLASH. INTERLEAD
FLASH SHALL NOT EXCEED 0.254 mm ( $0.010^{\circ}$ ) PER SIDE

N Package
28-Lead PDIP (Narrow 0.300)
(LTC DWG \# 05-08-1510)

*THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.010 INCH ( 0.254 mm )

## LTC1605-1/LTC 1605-2

## TYPICAL APPLICATION



Figure 17. This Is the Timing Relationship Between the Selected MUX Channel, Its Conversion Data and the ADC and MUX Control Signals When Using the Sample Program In Listing 1. The Conversion Process Is Latency Free: the Data Is Always Generated Based On the Currently Selected MUX Input

## RELATGD PARTS

| PART NUMBER | DESCRIPTION | COMMENTS |
| :--- | :--- | :--- |
| LT $^{\circledR} 1019-2.5$ | Precision Bandgap Reference | $0.05 \%$ Max, 5ppm/ ${ }^{\circ} \mathrm{C} \mathrm{Max}$ |
| LTC1274/LTC1277 | Low Power 12-Bit, 100ksps ADCs | 10 mW Power Dissipation, Parallel/Byte Interface |
| LTC1415 | Single 5V, 12-Bit, 1.25Msps ADC | 55 mW Power Dissipation, 72dB SINAD |
| LTC1419 | Low Power 14-Bit, 800ksps ADC | True 14-Bit Linearity, 81.5dB SINAD, 150mW Dissipation |
| LT1460-2.5 | Micropower Precision Series Reference | $0.075 \%$ Max, 10ppm $/{ }^{\circ} \mathrm{C}$ Max, Only 130 $\mu A$ Supply Current |
| LTC1594/LTC1598 | Micropower 4-/8-Channel 12-Bit ADCs | Serial I/0, 3V and 5V Versions |
| LTC1604 | 16-Bit, 333ksps Sampling ADC | $\pm 2.5 \mathrm{~V}$ Input, 90dB SINAD, 100dB THD |
| LTC1605 | Low Power 100ksps 16-Bit ADC | Single 5V, $\pm 10 \mathrm{~V}$ Inputs |

